

Innovating Energy Technology

http://www.fujielectric.com/products/semiconductor/ **FUJI POWER MOSFET**

Super J MOS[®] S2 series

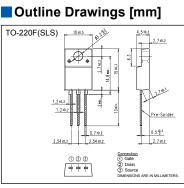
N-Channel enhancement mode power MOSFET

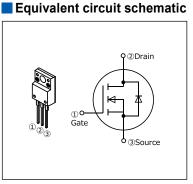
Features

Pb-free lead terminal **RoHS** compliant uses Halogen-free molding compound

Applications

For switching





Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Drain Source Voltage	VDS	600	V	
Drain-Source Voltage	VDSX	600	V	V _{GS} =-30V
Continuous Drain Current	I _D	10	А	Tc=25°C Note*1,2
Continuous Drain Current		6.3	А	Tc=100°C Note*1,2
Pulsed Drain Current	1 _{DP}	32.4	А	Note *2
Gate-Source Voltage	V _{GS}	±30	V	
Non-Repetitive Maximum Avalanche Current	las	1.1	А	Note *3
Non-Repetitive Maximum Avalanche Energy	Eas	380	mJ	Note *4
Maximum Drain-Source dV/dt	dV _{DS} /dt	50	V/ns	V _{DS} ≤ 600V
Continuous	1	10	А	Tc=25°C Note*1,2
Diode Forward Current	I _{SD}	6.3	А	Tc=100°C Note*1,2
Pulsed Diode Forward Current	ISDP	32.4	А	Note *2
Peak Diode Recovery dV/dt	dV/dt	15	V/ns	Note *5
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note *6
Mariana Diasiastian	-	2.16		<i>T</i> _a =25°C
Maximum Power Dissipation	PD	20	W	<i>T</i> c=25°C
	T ch	150	°C	
Operating and Storage Temperature range	T _{stg}	-55 to +150	°C	
Isolation Voltage	Viso	2	kVrms	t=60sec, f=60Hz

Note *1 : Maximum duty cycle D=0.65 Note *2 : Limited by maximum channel temperature. Note *3 : Teh≤150°C, See Fig.1 and Fig.2 Note *4 : Starting Teh=25°C, IAs=0.7A, L=1.42H, VoD=60V, RG=50Ω, See Fig.1 and Fig.2 EAS limited by maximum channel temperature and avalanche current.

Note *5 : Iso≤8.1A, -di/dt≤100A/µs, Vos peak≤ 600V, Tel≤150°C. Note *6 : Iso≤8.1A, dV/dt≤15V/ns, Vos peak≤ 600V, Tel≤150°C.

Electrical Characteristics at Tc=25°C (unless otherwise specified) Static Ratings

Parameter	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I₀=250µA		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} I₀=100µA		2.5	3.0	3.5	V
Zero Gate Voltage Drain Current	loss	V _{DS} =600V V _{GS} =0V	T _{ch} =25°C	-	-	25	-μA
		V _{DS} =480V V _{GS} =0V	<i>T</i> _{ch} =125°C	-	-	250	
Gate-Source Leakage Current	Igss	V _{DS} =0V V _{GS} = ± 30V	- ·	-	10	100	nA
Drain-Source On-State Resistance	RDS(on)	V _{GS} =10V I _D =4.1A		-	0.336	0.38	Ω
Gate resistance	RG	f=1MHz, open drain		-	17.2	-	Ω

Dynamic Ratings

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	g _{fs}	V _{DS} =25V I _D =4.1A	3.5	7	-	S
Input Capacitance	Ciss	V _{DS} =400V	-	588	-	
Output Capacitance	Coss	V _{GS} =0V	-	17.5	-	
Reverse Transfer Capacitance	Crss	f=250kHz	-	3	-	
Effective output capacitance, energy related (Note *7)	C _{o(er)}	V _{DS} =0400V V _{GS} =0V	-	42	-	pF
Effective output capacitance, time related (Note *8)	C _{o(tr)}	V _{DS} =0400V V _{GS} =0V I _D =constant	-	138	-	
talon)	t _{d(on)}	V_{DD} =400V, V_{GS} =10V J_{D} =4.1A, R_{G} =18Ω See Fig.3 and Fig.4	-	12.5	-	ns
Turn-On Time	tr		-	22.5	-	
Turn-Off Time	t _{d(off)}		-	89.5	-	
	<i>t</i> r		-	21	-	
Total Gate Charge	QG		-	27.5	-	nC
Gate-Source Charge	Q _{GS}	V_{DD} =400V, V_{GS} =10V	-	8	-	
Gate-Drain Charge	Q _{GD}	_ /₀=8.1A _ See Fig.5	-	7.5	-	
Drain-Source crossover Charge	Qsw		-	5	-	

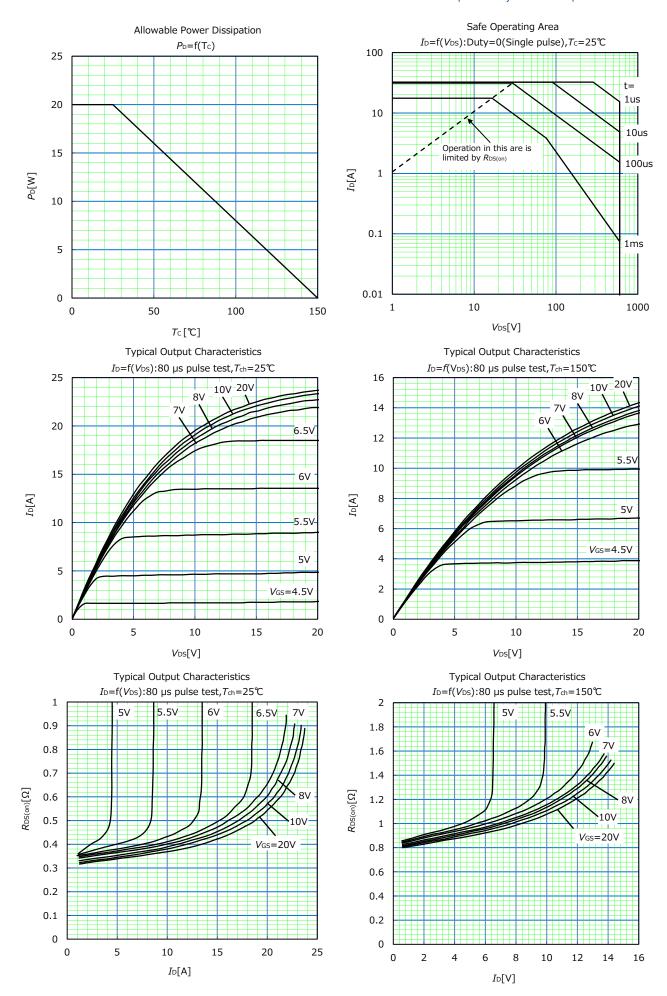
Note *7 : $C_{0(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V. Note *8 : $C_{0(er)}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{DS} is rising from 0 to 400V.

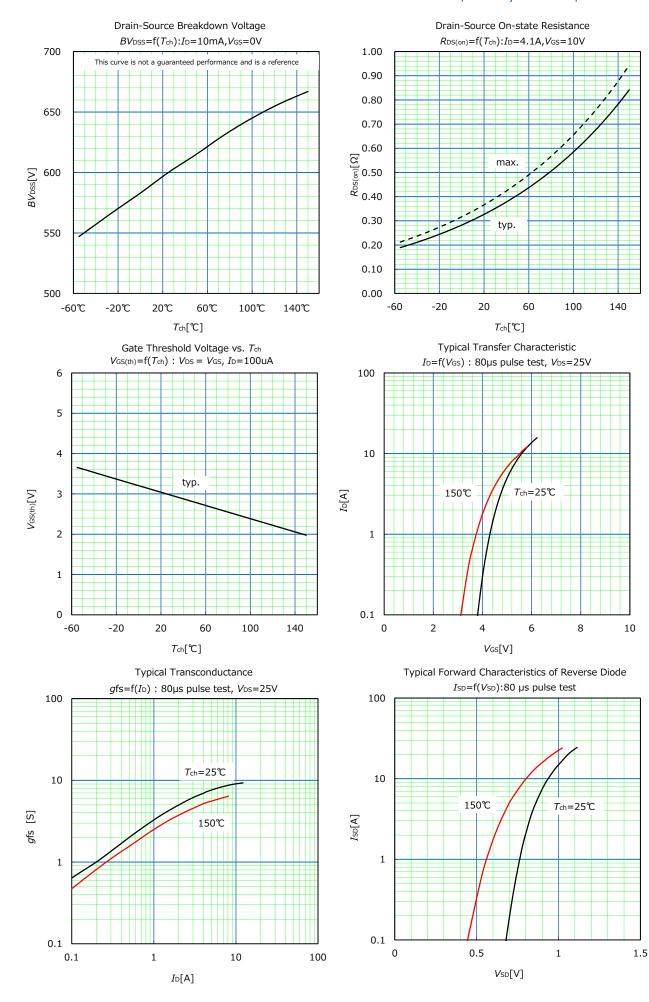
Reverse Diode

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Diode Forward On-Voltage	V _{SD}	I _{SD} =8.1A, V _{GS} =0V T _{ch} =25°C	-	0.9	1.35	V
Reverse Recovery Time	trr	- V _{op} =400V, / _{sp} =8.1A -di/dt=100A/μs 7 _{ch} =25°C See Fig.6 and Fig.7	-	270	-	ns
Reverse Recovery Charge	Qrr		-	2.6	-	μC
Peak Reverse Recovery Current	I _{rp}		-	18.7	-	А

Thermal Resistance

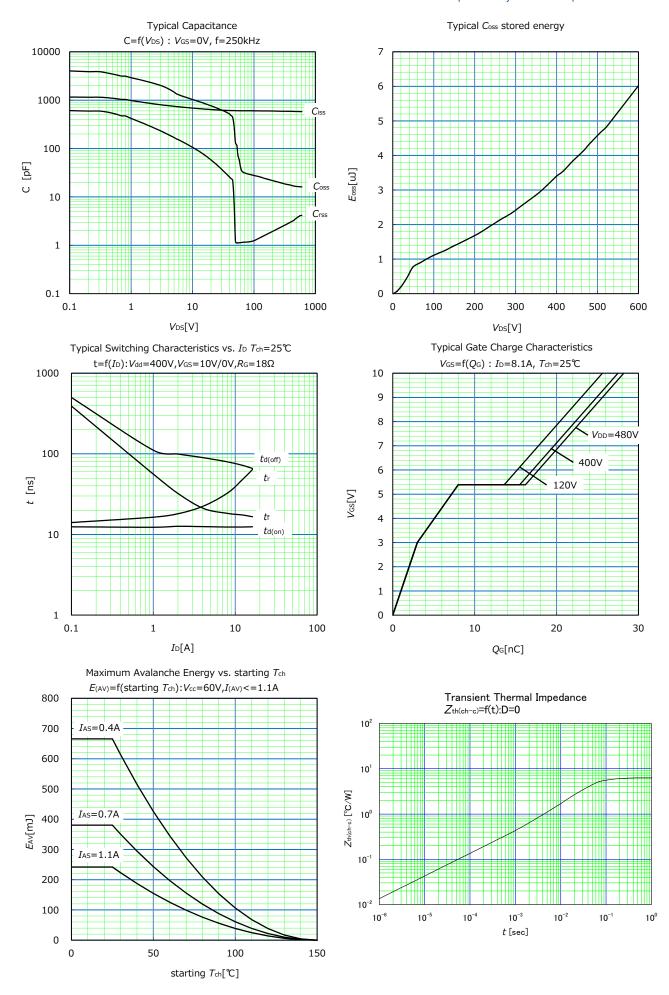
Parameter	Symbol	min.	typ.	max.	Unit
Channel to Case	Rth(ch-c)	-	-	6.25	°C/W
Channel to Ambient	Rth(ch-a)	-	-	58	°C/W

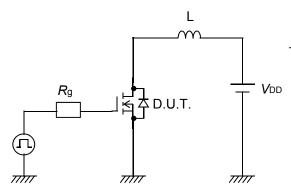




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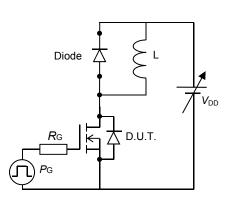


Fig.3 Switching Test circuit

+10V -15V /AV 0 /AV /DS /D

Fig.2 Operating waveforms of Avalanche Test

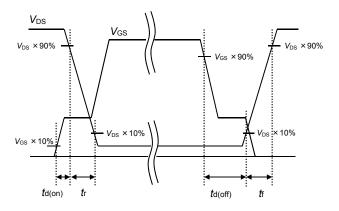


Fig.4 Operating waveform of Switching Test

VGS, VDS

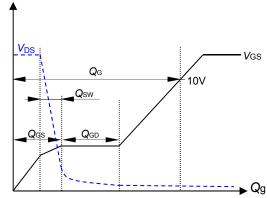
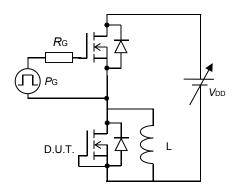
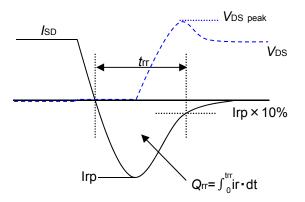


Fig.5 Operating waveform of Gate charge Test





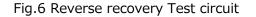


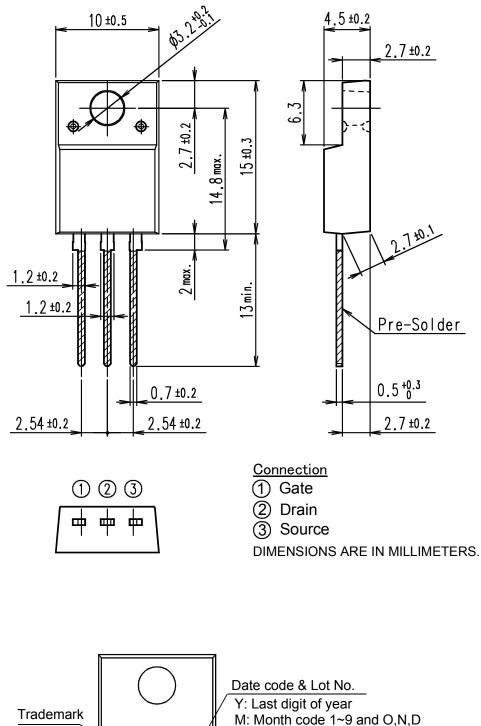
Fig.7 Operating waveform of Reverse recovery Test

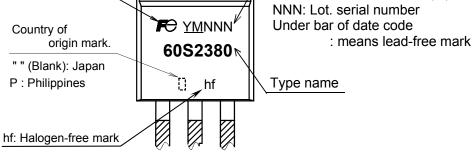
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Outview: TO-220F(SLS) Package





* The font (font type,size) and the trademark-size might be actually different.

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